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Orientation of Few-Layer MoS₂ Films: In-Situ X-ray Scattering Study **During Sulfurization**

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sulfurization in a standard growth chamber, only a limited number of analytical techniques can be used to elucidate the in-process phase transformation. Here, we present a comprehensive real-time study of the growth of few-layer MoS₂ films by sulfurization of Mo films using in situ grazing-incidence wide-angle X-ray scattering. We demonstrate that the



process gas flow, and thus the sulfur partial vapor pressure, is the key control parameter for the few-layer MoS₂ layer orientation while all other process parameters remain fixed. Tracking the crystallization of few-layer MoS₂ layers in real-time allowed us to estimate the activation energy required for both horizontal and vertical orientations. Growth of either horizontal or vertical MoS₂ was observed without a metastable transition between them throughout the sulfurization.

INTRODUCTION

 MoS_{2i} a promising member of the transition metal dichalcogenide (TMD) family, draws serious attention of the scientific community due to its unique optical, electrical, and catalytic properties. The presence of van der Waals (vdW) forces between the weakly bound two-dimensional (2D) molecular layers in the TMDs makes them unique compared to their bulk counterparts.^{1,2} TMD materials consist of a layered structure and have the general formula MX₂, where M represents a transition metal (Mo or W) and X refers to a chalcogen (S, Se, or Te). In MoS_{2} , the presence of a strong ionic bonding between the Mo and S atoms along with the presence of a weak vdW force between the different layers of MoS₂ enables thickness-dependent thermal, band gap and optical properties.³⁻⁵ Numerous methods are available to produce few-layer or monolayer MoS₂ such as pulsed laser deposition,⁶ exfoliation of bulk crystals,^{4,7} or chemical vapor deposition (CVD).^{8,9} CVD is an established technique for the fabrication of MoS₂ films with control over grain size,¹⁰ layer numbers,¹¹ nucleation,¹² and lattice-orientation¹³ by means of the growth parameters. Choudhary et al.¹⁴ confirmed the influence of strain energy build-up during the growth on 2D layer orientation and the growth mode. It is already well reported that TMD materials with a hexagonal close-packed structure like MoS₂ layers can grow with horizontal or vertical

alignment depending on the fabrication conditions. In the horizontal alignment (HA), the basal planes of the MoS_2 layers are oriented parallel to the substrate surface and the crystallographic *c*-axis is aligned along the substrate surface normal. HA MoS₂ layers are widely used in the field of optoelectronics^{3,4} and electronics.^{15,16} In the vertical alignment (VA), however, the basal planes are perpendicular to the substrate surface and the *c*-axis is perpendicular to the surface normal. VA MoS₂ layers are gaining particular interest due to their chemically reactive edges, which can be used for solar cells,¹⁷ water disinfection,¹⁸ water splitting,¹⁹ and hydrogen evolution reactions (HER).²⁰ The spatial orientation of MoS_2 layers is important in determining the applications of this material.^{21,22} Therefore, precise control over the growth orientations of these 2D TMD materials is critical to optimize their desired material properties and device functionalities.

Due to the scientific and technological importance of this promising material, numerous studies have already been

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performed to investigate the underlying growth control parameters and their influence on the growth mechanisms. Two-zone sulfurization,²³ which is already a standard method for growing MoS₂ layers, is effective and reliable for the fabrication of HA and VA MoS2 layers. A large class of parameters responsible for the observed growth of HA and VA-MoS₂ layers has not yet been fully explored.^{18,20,24} On the basis of the previous studies, it turns out that the main process controlling the formation of either HA or VA growth is the diffusion of S into Mo, depending on the temperature and local concentration of S.^{20,25} The thickness of the initial Mo layer is also a crucial parameter for determining the growth mode.²⁴ For thicker (\gtrsim 3 nm) Mo layers, VA growth is dominant, whereas HA growth occurs for thinner layers. Other key factors controlling the growth of MoS₂ include pressure, temperature, and local sulfur concentration gradient in the sulfurized film and substrate.²⁶ In addition to this, Shang et al.²⁶ proposed Mo diffusion as a controlling factor for MoS₂ growth due to the extremely low diffusivity of Mo compared to sulfur.

It is widely accepted that the formation of VA MoS₂ in a two-zone furnace is mainly driven by rapid sulfur diffusion along vdW gap.^{18,20,24} In that case, the annealing temperature is selected in the range from 500 to 800 °C and a short annealing time (10-20 min) is applied. VA MoS₂ was observed for a fast heating rate (in the order of tens of Kelvin per minute)²⁷ and when the thickness of Mo films exceeds 3 nm. Sojkova et al.9 reported the transformation from VA to HA MoS₂ layer alignment by decreasing the heating rate while sulfurizing Mo films of the same thickness (3 nm). However, the role of sulfur partial vapor pressure (or sulfur concentration or carrier gas flow rate) on MoS₂ growth is by far less explored than the other growth parameters. Bo Chen et al.²⁸ demonstrated the preparation of large-area uniform monolayer MoS₂ films by an atmospheric pressure CVD method. They were able to control the sulfur partial vapor pressure by a sulfur vapor counterflow diffusion setup, which lowers the sulfur concentration in the reaction zone. Therefore, the sulfur partial vapor pressure seems to be another critical factor influencing the growth of MoS₂ films, but its effect on the growth orientation is relatively unexplored.

Here, we present a one-zone CVD method leading to the growth of either HA or VA MoS₂ films by sulfurizing Mo films with the same thickness. The sulfur powder was located directly under the Mo film substrate. The only control parameter is the sulfur vapor pressure, while the deposition temperature and heating rate were kept constant. Our investigations are supported by real-time and in situ grazingincidence wide-angle X-ray scattering (GIWAXS). We observed the growth of either HA or VA MoS₂ as a function of sulfur partial vapor pressure controlled by the nitrogen flow through the CVD chamber. No metastable states or transitions between the two alignments were observed. To acquire a complete picture, we also calculated the activation energy for each case by mathematical modeling. Our observations confirm a sulfur diffusion-driven growth of HA and VA MoS₂ layers starting from the interface into the bulk of the Mo layers, while the final orientation is determined by a delicate balance between the film's surface energy and sulfurization rate given by the sulfur concentration at the vapor-solid interface. This breakthrough monitoring of phase transformations directly in a CVD chamber using the real-time GIWAXS technology described here is not limited to this particular

system. In fact, it has more general consequences that can also be applied to other thin film growth processes.

EXPERIMENTAL DETAILS

Preparation of MoS₂ **Layers.** The few-layer MoS₂ films were prepared on *c*-plane sapphire substrates by sulfurization of Mo layers with a thickness of 3 nm. The dimensions of the sapphire substrates were $1 \times 1 \text{ cm}^2$. The Mo layers were deposited by DC magnetron sputtering, and details can be found in ref 9. The few-layer MoS₂ films were prepared by one-zone sulfurization in a specially designed CVD reactor (Figure 1). Sulfur powder (0.5 g) was heated next to the sample placed near the center of the CVD reactor.



Figure 1. Schematic illustration of the core of a CVD reactor with sample holder, consisting of a glass tube enclosed by aluminum windows attached to the inlet and outlet flanges. Note that the sample was oriented downward with the normal of the sample along the q_z direction.

In-situ Synchrotron GIWAXS Measurements. In situ GIWAXS measurements were performed at the SAXS beamline of the Elettra synchrotron radiation facility in Trieste, Italy. X-ray photons with an energy of 16 keV (wavelength of 0.7749 Å) were used. The photon flux on the sample was approximately 10¹² photons/s. The X-ray beam size was adjusted to $3 \text{ mm} \times 1 \text{ mm} (H \times V)$ by a slit system. The X-ray beam divergence was 0.6 mrad \times 0.3 mrad (H \times V). The quartz tube of the CVD reactor shown in Figure 1 was inserted into the heating chamber as shown in Figure S1. The experimental details of the sample holder assembly are shown in Figure S2. The entire system was mounted on a heavy-duty hexapod (H-840, PI) with six-axis freedom, which allowed us to adjust the sample to the X-ray beam and set an angle of incidence of 0.2°. A transparent quartz glass tube was equipped on both sides with aluminum windows with a thickness of 30 μ m, showing X-ray transparency of 95% for 16 keV photon energy. The windows were attached to the quartz tube by stainless steel flanges with O-ring Viton seals. The entrance and exit windows had a diameter of 20 mm and 55 mm, respectively. The sample was mounted on a stainless steel holder placed above the sulfur crucible, and the normal to the sample surface was oriented in the vertical direction (Figure 1). The inert atmosphere in the CVD tube was maintained by nitrogen at a flow rate of 50 sccm and a pressure of 0.5 bar for HA MoS₂ and no flow for VA MoS₂. The sample-to-detector distance was fixed to 845 mm. The X-ray detector used in the experiment was a CMOS-based Pilatus3 1 M (Dectris, Switzerland). The pixel size of the detector was 172 μ m \times 172 μ m (H × V) with a total sensor area of 168.7 × 179.4 mm^2 (981 × 1043 pixels, H × V). The scattered X-ray intensity



Figure 2. Sulfurization of Mo films at two different N_2 flows. GIWAXS patterns of (a) initial Mo and (b) final HA MoS₂ film after sulfurization at a flow rate of 50 sccm and (c) initial Mo and (d) final VA MoS₂ film after sulfurization at zero flow rate. The insets illustrate the orientation of MoS₂ layers. The dashed lines indicate the limits for profile integration.

was acquired continuously with an exposure time of 10 and 5 s for the growth of HA MoS_2 and VA MoS_2 , respectively. During the in situ experiment, systematic sample displacement was observed due to thermal expansion of the mounting assembly, which was compensated by counter-movement of the entire CVD chamber using the hexapod.

RESULTS AND DISCUSSION

Our study was performed in a custom-designed CVD chamber dedicated to real-time and in situ GIWAXS. Figure 1 shows the schematic illustration of the experimental setup described in detail in Experimental Details and Supporting Information. The GIWAXS patterns are represented in reciprocal space, where the q_z and q_r coordinates denote the scattering along the substrate normal and in the substrate plane, respectively. The GIWAXS patterns taken before and after sulfurization of Mo films at a nitrogen flow rate of 50 sccm are shown in Figure 2a,b, respectively. The subtracted GIWAXS pattern between the final and initial states at this flow rate is shown in Figure S3a. After sulfurization, the layer shows a strong 002 diffraction spot located along the q_z direction at $q_z = 1$ Å⁻¹. This suggests that the (001) lattice planes of MoS₂ are oriented parallel to the sample surface with the *c*-axis oriented along the substrate surface normal, corresponding to HA MoS₂ films. On the other hand, GIWAXS patterns recorded before and after sulfurization of Mo films at zero nitrogen flow rate are shown in Figure 2c,d, respectively. The subtracted GIWAXS pattern between the final and initial states at zero flow rate is shown in Figure

S3b. The 002 diffraction spot oriented along the q_r direction at $q_r = 1 \text{ Å}^{-1}$ confirms a perpendicular orientation of the (001) lattice planes with respect to the sample surface with the *c*-axis aligned in the plane of the film, which corresponds to VA MoS₂ films. We note that elastic X-ray scattering of the primary beam in nitrogen atmosphere of the CVD chamber is responsible for the strong observed intensity close to the origin of reciprocal space in all GIWAXS patterns. Furthermore, the inaccessible region of GIWAXS pattern along the q_z direction at $q_r = 0$ Å⁻¹, also known as the missing wedge, which is inherent to the scattering geometry used, prevents a direct comparison of the total phase volumes in HA and VA MoS₂ films.²⁹ However, this specific limitation of the GIWAXS measurement geometry does not prevent a comparison of the relative kinetics of the phase transformations during films sulfurization as described in the next section.

The CVD heating ramp of 25 °C/min and the maximum temperature of 600 °C held for 30 min were identical for both orientations of MoS_2 . In the HA MoS_2 sample, the inert atmosphere inside the CVD chamber was maintained with a nitrogen flow rate of 50 sccm; this reduced the sulfur vapor partial pressure on the sample. On the other hand, for VA MoS_2 no nitrogen flow through the CVD reactor was used. Instead, it was only purged with nitrogen before the heating process. Possible gas backflow was prevented by using a one-way valve at the outlet of the CVD chamber. Consequently, the

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Figure 3. The 002 intensity profiles for (a) HA MoS₂ and (b) VA MoS₂ films at different temperatures.



Figure 4. (a) The normalized 002 intensity for HA and VA MoS_2 layers as a function of time and temperature. The blue line renders the best fit by the Dietz model for the growth of HA MoS_2 . (b) The calculated coherent crystalline domain size along with *d*-spacing and (c) fwhm of χ profiles as a function of time and temperature.

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sulfur partial vapor pressure on the sample was higher throughout VA MoS₂ growth than during HA MoS₂ growth.

In order to quantify the temporal evolution of the Mo phase transformation during sulfurization, we extracted a series of reciprocal space cuts and evaluated them as a function of time. The selected intensity profiles of the 002 diffraction spot taken along the q_z direction in the χ range $(-20^\circ, +20^\circ)$ during the phase transformation leading to HA MoS₂ are shown in Figure 3a. A detailed description of the χ -profiles extraction can be found in Supporting Information. For comparison, intensity profiles extracted along the q_r (i.e., in-plane) direction of the χ range $(72^{\circ}, 86^{\circ})$ shown in Figure 3b were used to follow the Mo phase transformation toward VA MoS₂. In the case of VA MoS₂ films, the randomly oriented *c*-axis in the film plane and the grazing-incidence measurement geometry result in a much lower intensity of the 002 diffraction compared to that of the HA MoS₂ film. In both cases, the onset of the early phase transformation toward the MoS₂ phase can be already seen at close to 450 °C. The evaluation of the phase diagram of the Mo–S system^{26,30} in the sulfur-rich region (S/Mo > 2) under a pressure of 1 atm reveals a universal CVD growth window for the MoS₂ phase from sulfur gas starting at 444.6 °C, which coincides well with the onset of the phase transition observed in our experiment. The phase transition reaches saturation for temperatures above 500 °C. The gradual narrowing of the 002 diffraction peak indicates an increasing size of coherently scattering domains of MoS2 crystals in both films. A key observation in our experiments is the growth of either exclusively HA or exclusively VA MoS₂ phases. No reorientations between the two were detected during sulfurization. This suggests that the final orientation is determined by the extent of the sulfur diffusion from the vapor-solid interface into the bulk,^{27,31} driven by the sulfur vapor pressure alone, since the solubility of sulfur in molybdenum is negligible.³² Also, apparently once the growth of a given orientation has nucleated, there is no possibility of switching back. However, this observation, which applies to the formation of few-layer MoS₂, cannot be generally extended to the sulfurization of thick Mo films.

To provide a quantitative analysis of phase transformations for both orientations, the normalized integral intensities of the 002 diffraction peaks for HA and VA MoS_2 are plotted as functions of time and temperature in Figure 4a. Both HA and VA aligned MoS_2 samples show a similar evolution of the area under the 002 diffraction peak.

To facilitate the understanding of the phase transformations in both cases and to quantify the analysis, we implemented the mathematical models developed by Avrami and Dietz.^{33–37} The activation energy was determined by applying the Avrami model since it provides the most straightforward crystallization kinetics model. As a first approximation, we used the Avrami model to fit the degree of phase conversion α as a function of time

$$\alpha(t) = 1 - e^{(-1)mIA\int X(t)dt}$$
⁽¹⁾

$$X(t) = e^{(-E/RT(t))}t^{m-1}$$
(2)

where *m* is the dimensionality of the growth (m = 3 in our case; see below), *E* is the activation energy, *R* is the universal gas constant, *T* is the temperature, *A* is the pre-exponential factor, and *I* is the integral area under the 002 diffraction peak.³⁸ The functional dependence $\alpha(t)$ was intentionally split

into two parts to allow a simpler representation by an auxiliary function X(t).

In the modeling, the temperature was considered to be linear with time. The Avrami model provided activation energies of 324 ± 2 and 329 ± 3 kJ mol⁻¹ for HA and VA MoS₂, respectively. The published values of activation energies^{31,32,3} for sulfurization of bulk Mo films range from 105 to 326 kJ mol⁻¹. On the basis of the measured values of activation energies for both orientations, it can be concluded that the growth of differently oriented MoS₂ has very similar activation energies within their corresponding confidence intervals. Since the only different growth parameter was the nitrogen gas flow, the origin of the different orientation should therefore be seen in the different sulfur vapor pressure. To further support our conclusions on the influence of the sulfur vapor pressure on the formation of differently oriented MoS₂ phases, we performed in situ X-ray absorption measurements of the process gas atmosphere directly in the CVD chamber (Supporting Information). The X-ray absorption measurements confirm an increased sulfur vapor pressure for VA MoS₂ growth compared to HA MoS₂ growth.

In the following, due to the better statistics of the scattered X-ray data for the growth of HA MoS₂ and similarities in the activation energies with VA MoS₂ we have performed the refined fitting procedure only for HA MoS₂ films. All diffraction peaks were fitted with a linear background. The Avrami model was successful in describing the initial stage of transformation kinetics. However, it fails to describe the slowdown of the crystallization process at the temperatures above the phase transition in the range between 500 and 550 °C, also known as the secondary or post-Avrami crystallization.^{36–38} To overcome this drawback of the Avrami model, a modified Avrami model, so-called Dietz model, was applied.⁴ The best fit of the Dietz model for HA MoS₂ is shown by the blue curve in Figure 4a, which was obtained for the parameter a = 0.9 (an explanation can be found in Supporting Information), dimensionality m = 3, and activation energy 321 ± 1.3 kJ mol⁻¹. However, as can be seen the application of the refined Dietz model does not change the activation energies and only influences the secondary crystallization rate as expected.

A rapid increase of the 002 diffraction intensity occurs between 450 and 500 °C. Moreover, in this temperature range, we observe almost a doubling of the average coherent crystalline domain size from about 30 Å to almost 60 Å, as shown in Figure 4b. This indicates the growth of MoS_2 nuclei from the vapor-solid interface of the Mo layer in this temperature range. Simultaneously, there is a decrease of the (002) interplanar spacing from an initial 6.2 \pm 0.05 Å to a consolidated bulk value of 6.1 \pm 0.01 Å. On the other hand, in the secondary crystallization stage above 500 °C, the further growth of the coherent crystalline domain size implies crystal coarsening with increasing temperature. At this stage, no significant change in the (002) interplanar spacing parameter can be detected. The simple Avrami model fails to describe exactly this phase, and the use of a more advanced Dietz model allows a good fit to the data even in this secondary crystallization phase without influencing the activation energies.

Finally, to assess the change in film mosaicity $\Delta \chi$ during the film sulfurization, that is, the mean misalignment of the crystal *c*-axis with respect to the surface normal, we extracted χ -cuts from the GIWAXS patterns as described in the Supporting

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Information. For the growth of HA MoS₂, fwhm of the χ -cuts integrated in the *q*-range of 0.95–1.1 Å⁻¹ are shown in Figure 4c. We observe a decreasing angular misalignment $\Delta \chi$ of MoS₂ crystals from the substrate surface's normal direction in the primary phase of nucleation and crystal growth. The mean value of $\Delta \chi$ drops by more than 15° in the temperature range between 450 and 500 °C. In the following secondary crystallization stage, no significant changes in crystal orientations were observed.

Within the limits of our investigations, the observed difference in the growth of HA versus VA MoS₂ depends solely on the concentration of S atoms at the vapor-solid interface, since all other reaction parameters were kept constant. The growth of either HA or VA MoS₂ is controlled by a balance between the surface energy of the final film and the reactivity of Mo with S, which is limited by the diffusion of S atoms into the Mo bulk. The surface energy of VA films is less favorable compared to HA films because the edge sites surface energy is nearly 2 orders of magnitude above that of the basal plane.⁴⁰ This is also the reason why thin Mo films almost exclusively sulfurize in HA configuration.²⁴ On the other hand, in the limit of the thick films the enhanced diffusion of S atoms along the vdW gap favors the growth of VA MoS₂ films.^{20,27} The evidence from this study suggests that the growth of VA MoS₂ at high S concentration is preferable to HA due to the efficient and rapid growth of MoS₂ phase. In this case, the fast diffusion kinetics of S into Mo bulk due to high sulfur pressure, forming MoS₂ phase, even prevailed over the lower surface energy offered by the alternative HA configuration. In contrast, under S deficient conditions induced by N2 flow, the lower surface energy of the HA configuration outweighs the rapid diffusion-driven growth of the VA configuration.

CONCLUSIONS

Control over the orientation of few-layer MoS₂ films plays a crucial role in determining their applications. We performed a controlled sulfurization of Mo-coated substrates in a one-zone CVD furnace by fixing all parameters except the nitrogen flow through the reactor. We established that in the case of rapid sulfurization, the sulfur partial vapor pressure is the key parameter that determines the orientation of the final few-layer MoS₂ films. HA and VA MoS₂ films were fabricated with a nitrogen flow of 50 sccm and without flow, respectively. The activation energies of Mo sulfurization leading to HA or VA MoS₂ appear to be essentially identical, as evidenced by in situ GIWAXS. The origin of the different MoS₂ orientations at different sulfur vapor pressures can be explained by the competition between the fast sulfur diffusion along the vdW gap and surface energy minimization leading to VA or HA MoS₂, respectively. The presented real-time GIWAXS method opens the possibility to study the mechanisms behind the phase transformations in a large number of low-dimensional materials in CVD reactors in general. While the present results have important implications for a deeper understanding of the delicate balance between the growth of HA and VA MoS₂, further experimental and theoretical studies are required to fully understand the mechanisms underlying the findings.

ASSOCIATED CONTENT

Supporting Information

The Supporting Information is available free of charge at https://pubs.acs.org/doi/10.1021/acs.jpcc.1c01716.

Experimental details and additional explanation of data analysis and fitting (PDF)

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Notes

The authors declare no competing financial interest.

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